EXS210119-01

Uncooled Butterfly 5pin λ=820nm

Revision:	1.0
Date:	27-01-2020
Confidentiality:	**None**

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1. SCOPE

1.1 PURPOSE

The purpose of this document is to specify the electro-optical performance and dimensions of superluminescent light emitting diode (SLED).

1.2 RESPONSIBILITY

EXALOS is responsible for establishing, implementing and maintaining this procedure. The Quality representative shall ensure that a timely Engineering Change Notice (ECN) is issued in accordance with EXALOS procedure for any changes.

2. REFERENCE DOCUMENT

- EXS-WI-0001 Visual Inspection Criteria SLED Chip on Submount Procedure
- MIL STD 883 C method.
- Bellcore GR-468-CORE.

3. ELECTRO-OPTICAL PERFORMANCE (T_{SLED} = 25°C)

Parameter	Symbol	Cond.	Min	Typ	Max	Unit
Operating Current	I_{op}				120	mA
Power in SMF	P_o	$I_{op,\ max}$	2	3		mW
Center Wavelength	λ_c	$I_{op,\ max}$	800	820	840	nm
Bandwidth FWHM		$I_{op,\ max}$	20	25		nm
Spectral ripple [RB=0.05nm]		$I_{op,\ max}$		0.1	0.2	dB

4. ABSOLUTE MAXIMUM RATINGS

Stresses beyond the absolute maximum ratings may cause permanent damage to the device.
Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Parameter	Symbol	Cond.	Min	Max	Unit
Forward current	I_F			130	mA
Reverse voltage	V_R			-2	V
Forward voltage	V_F	$I_{F,max}$		3.0	V
Storage temperature	T_{stg}		-40	85	°C
Operating temperature	T_{op}	$I_{F,max}$	-20	65	°C
Storage humidity		<30°C >30°C	5	95 85	% r.h. % r.h.
Lead soldering temperature				260	°C
Lead soldering duration				10	s
ESD		human b.m		500	V

4.1 THERMISTOR

Parameter	Symbol	Cond.	Min	Typ	Max	Unit
Thermistor PT1000 platinum temperature sensor (RTD)*	R_T	DIN EN 60751		1		kΩ

5. SCREENING

The produced 820nm SLED Module is required to meet all operating conditions specified in Table 3, Electro-Optical Performance Specifications after being subjected to the following screening tests.

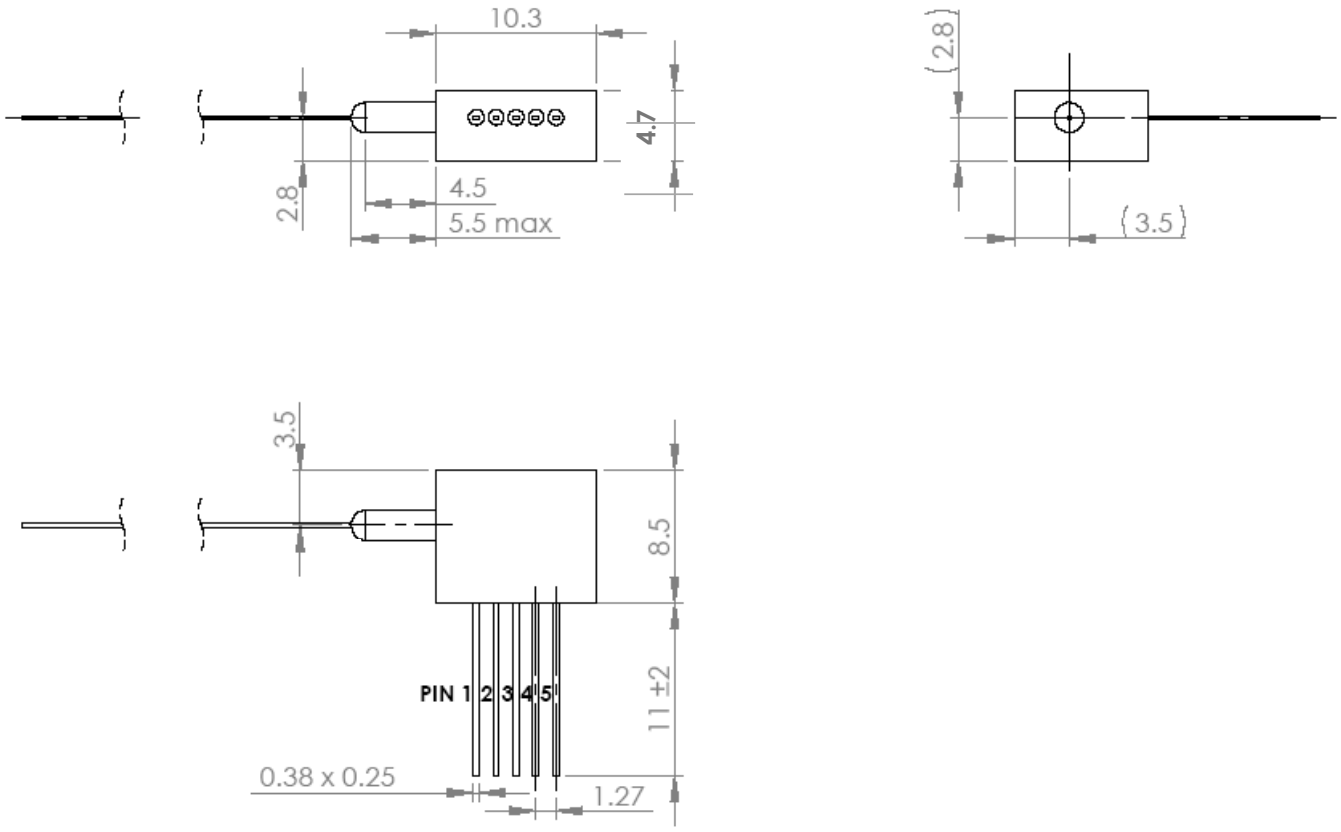
Test Item	Test Conditions	Reference
Seal	Fine: Condition A1 Gross: Condition C	MIL-STD-883, Method 1014 Temperature max 85°C
Temperature Cycling	-40°C to +85°C, ramp rate >= 5°C/min 10 cycles	MIL-STD-883, Method 1010

* Type IST-AG P1K0.161.3P.C.M. 1kΩ at 0°C

6. PACKAGE DIMENSIONS [mm]

3rd Angle projection

Tolerances: .X ± 0.15 mm
.XX ± 0.05 mm



Butterfly 5 pin	
Pin	**Function**
1	**RTD Thermistor**
2	**RTD Thermistor**
3	**SLED Anode (+)**
4	**SLED Cathode (-)**
5	**Case**

7. FIBRE AND CONNECTOR

Part	Description
SM Fibre	SM 5/125 Corning HI780
Tight buffer secondary coating	250 μm
Fiber pigtail length [min]	1m
Optical connector	FC/APC Narrow Key (2.0mm)

8. IMPORTANT NOTES

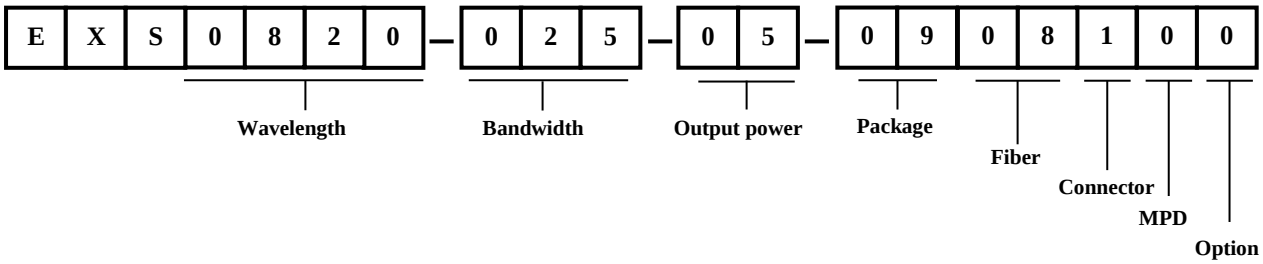
1. Avoid electrostatic discharges, which may destroy the SLED.
2. Never use the SLED module without heat sinking.
3. Adequate eye protection against laser radiation should be used while handling and operating the module.
4. EXALOS declines any responsibility if the device is used in applications where human life may be endangered.
5. Back reflections may influence the output power and spectral characteristics of the SLED. The use of optical isolators and/or angled connectors is recommended. Back reflections of less than -30dB are recommended.

9. ORDERING INFORMATION

Please use the following **part number** to order product from EXALOS:

E	X	S	2	1	0	1	1	9	–	0	1

9.1 TECHNICAL DESCRIPTION



10. REVISION HISTORY

Revision History				
Rev.	**Description**	**ECN**	**Date**	**Released**
1.0	Original version		27.01.2020	Rezzonico